Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: **B32620 ... B32621**

Date: May 2009

Typical applications
- Compact fluorescent lamps (CFL)
- SMPS

Climatic
- Max. operating temperature: 105 °C
- Climatic category (IEC 60068-1): 55/100/56

Construction
- Dielectric: polypropylene (PP)
- Stacked-film technology
- Plastic case (UL 94 V-0)
- Epoxy resin sealing

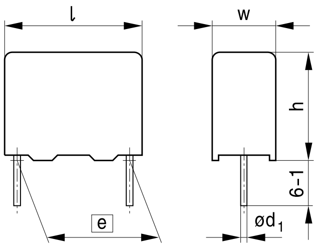
Features
- Very high pulse strength
- Very good self-healing properties
- Smallest possible dimensions
- High contact reliability

Terminals
- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

Marking
Manufacturer's logo,
rated capacitance (coded),
cap. tolerance (code letter), rated voltage,
date of manufacture (coded),
for lead spacing 7.5 mm: style (MKP),
for lead spacing 10 mm: lot number, series number (621)

Delivery mode
Bulk (untaped)
Taped (Ammo pack or reel)
For notes on taping, refer to chapter "Taping and packing“.

Dimensional drawing



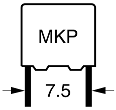
Dimensions in mm

Lead spacing $\boxed{e}$ ±0.4	Lead diameter d_1	Type
7.5	0.5	B32620
10.0	0.6[1)]	B32621

1) 0.5 mm for capacitor width w = 4 mm

Overview of available types

Lead spacing	7.5 mm						10.0 mm				
Type	B32620						B32621				
Page	4						6				
V_R (V DC)	160	250	400	630	1000	1000	160	250	400	630	1000
V_{RMS} (V AC)	90	140	200	400	500	600	90	140	200	400	500
C_R (nF)											
0.47											
0.68											
1.0											
1.5											
2.2											
3.3											
4.7											
6.8											
10											
15											
22											
33											
47											
68											
100											
150											
220											



B32620

High pulse (stacked)

Ordering codes and packing units (lead spacing 7.5 mm)

V_R V DC	V_{RMS} f ≤1 kHz V AC	C_R nF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
160	90	33	4.0 × 8.5 × 10.0	B32620A5333+***	8000	7200	6000
		47	4.0 × 8.5 × 10.0	B32620A5473+***	8000	7200	6000
		68	5.0 × 10.5 × 10.0	B32620A5683+***	6400	5600	4000
		100	5.0 × 10.5 × 10.0	B32620A5104+***	6400	5600	4000
		150	6.0 × 12.0 × 10.3	B32620A5154+***	5200	4400	3000
250	140	22	4.0 × 8.5 × 10.0	B32620A3223+***	8000	7200	6000
		33	4.0 × 8.5 × 10.0	B32620A3333+***	8000	7200	6000
		47	5.0 × 10.5 × 10.0	B32620A3473+***	6400	5600	4000
		68	5.0 × 10.5 × 10.0	B32620A3683+***	6400	5600	4000
		100	6.0 × 12.0 × 10.3	B32620A3104+***	5200	4400	3000
400	200	6.8	4.0 × 8.5 × 10.0	B32620A4682+***	8000	7200	6000
		10	4.0 × 8.5 × 10.0	B32620A4103+***	8000	7200	6000
		15	5.0 × 10.5 × 10.0	B32620A4153+***	6400	5600	4000
		22	5.0 × 10.5 × 10.0	B32620A4223+***	6400	5600	4000
		33	6.0 × 12.0 × 10.3	B32620A4333+***	5200	4400	3000
630	400	1.5	4.0 × 8.5 × 10.0	B32620A6152+***	8000	7200	6000
		2.2	4.0 × 8.5 × 10.0	B32620A6222+***	8000	7200	6000
		3.3	4.0 × 8.5 × 10.0	B32620A6332+***	8000	7200	6000
		4.7	4.0 × 8.5 × 10.0	B32620A6472+***	8000	7200	6000
		6.8	5.0 × 10.5 × 10.0	B32620A6682+***	6400	5600	4000
		10	5.0 × 10.5 × 10.0	B32620A6103+***	6400	5600	4000
		15	6.0 × 12.0 × 10.3	B32620A6153+***	5200	4400	3000
1000	500	1.5	4.0 × 8.5 × 10.0	B32620A0152+***	8000	7200	6000
		2.2	4.0 × 8.5 × 10.0	B32620A0222+***	8000	7200	6000
		3.3	5.0 × 10.5 × 10.0	B32620A0332+***	6400	5600	4000
		4.7	5.0 × 10.5 × 10.0	B32620A0472+***	6400	5600	4000
		6.8	6.0 × 12.0 × 10.3	B32620A0682+***	5200	4400	3000

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:
K = ±10%
J = ±5%

*** = Packaging code:
289 = Ammo pack
189 = Reel
000 = Untaped (lead length 6 −1 mm)

Ordering codes and packing units (lead spacing 7.5 mm)

V_R V DC	V_{RMS} f ≤1 kHz V AC	C_R nF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
1000	600	0.47	4.0 × 8.5 × 10.0	B32620J0471+***	8000	7200	6000
		0.68	5.0 × 10.5 × 10.0	B32620J0681+***	6400	5600	4000
		1.0	5.0 × 10.5 × 10.0	B32620J0102+***	6400	5600	4000
		1.5	5.0 × 10.5 × 10.0	B32620J0152+***	6400	5600	4000
		2.2	5.0 × 10.5 × 10.0	B32620J0222+***	6400	5600	4000
		3.3	5.0 × 10.5 × 10.0	B32620J0332+***	6400	5600	4000
		4.7	6.0 × 12.0 × 10.3	B32620J0472+***	5200	4400	3000

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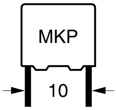

Ordering codes and packing units (lead spacing 10 mm)

V_R V DC	V_{RMS} f ≤1 kHz V AC	C_R nF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
160	90	47	4.0 × 7.0 × 13.0	B32621A5473+***	4000	6800	4000
		68	4.0 × 9.0 × 13.0	B32621A5683+***	4000	6800	4000
		100	5.0 × 11.0 × 13.0	B32621A5104+***	3320	5200	4000
		150	5.0 × 11.0 × 13.0	B32621A5154+***	3320	5200	4000
		220	6.0 × 12.0 × 13.0	B32621A5224+***	2720	4400	4000
250	140	2.2	4.0 × 7.0 × 13.0	B32621A3222+***	4000	6800	4000
		3.3	4.0 × 9.0 × 13.0	B32621A3332+***	4000	6800	4000
		4.7	4.0 × 9.0 × 13.0	B32621A3472+***	4000	6800	4000
		6.8	4.0 × 9.0 × 13.0	B32621A3682+***	4000	6800	4000
		10	4.0 × 9.0 × 13.0	B32621A3103+***	4000	6800	4000
		15	4.0 × 9.0 × 13.0	B32621A3153+***	4000	6800	4000
		22	4.0 × 9.0 × 13.0	B32621A3223+***	4000	6800	4000
		33	4.0 × 9.0 × 13.0	B32621A3333+***	4000	6800	4000
		47	4.0 × 9.0 × 13.0	B32621A3473+***	4000	6800	4000
		68	5.0 × 11.0 × 13.0	B32621A3683+***	3320	5200	4000
		100	6.0 × 12.0 × 13.0	B32621A3104+***	2720	4400	4000
400	200	10	4.0 × 9.0 × 13.0	B32621A4103+***	4000	6800	4000
		15	4.0 × 9.0 × 13.0	B32621A4153+***	4000	6800	4000
		22	5.0 × 11.0 × 13.0	B32621A4223+***	3320	5200	4000
		33	5.0 × 11.0 × 13.0	B32621A4333+***	3320	5200	4000
		47	6.0 × 12.0 × 13.0	B32621A4473+***	2720	4400	4000
630	400	2.2	4.0 × 7.0 × 13.0	B32621A6222+***	4000	6800	4000
		3.3	4.0 × 9.0 × 13.0	B32621A6332+***	4000	6800	4000
		4.7	4.0 × 9.0 × 13.0	B32621A6472+***	4000	6800	4000
		6.8	4.0 × 9.0 × 13.0	B32621A6682+***	4000	6800	4000
		10	4.0 × 9.0 × 13.0	B32621A6103+***	4000	6800	4000
		15	5.0 × 11.0 × 13.0	B32621A6153+***	3320	5200	4000
		22	6.0 × 12.0 × 13.0	B32621A6223+***	2720	4400	4000
		33	6.0 × 12.0 × 13.0	B32621A6333+***	2720	4400	4000

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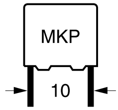

Ordering codes and packing units (lead spacing 10 mm)

V_R V DC	V_{RMS} f ≤1 kHz V AC	C_R nF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
1000	500	2.2	4.0 × 7.0 × 13.0	B32621A0222+***	4000	6800	4000
		3.3	4.0 × 9.0 × 13.0	B32621A0332+***	4000	6800	4000
		4.7	4.0 × 9.0 × 13.0	B32621A0472+***	4000	6800	4000
		6.8	5.0 × 11.0 × 13.0	B32621A0682+***	3320	5200	4000
		10	6.0 × 12.0 × 13.0	B32621A0103+***	2720	4400	4000

MOQ = Minimum Order Quantity, consisting of 4 packing units.
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Composition of ordering code

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Technical data

Operating temperature range	Max. operating temperature $T_{op,max}$		+105 °C
	Upper category temperature T_{max}		+100 °C
	Lower category temperature T_{min}		−55 °C
	Rated temperature T_R		+85 °C
Dissipation factor tan δ (in 10^{-3})	at	$C_R \leq 0.1\ \mu F$	$0.1\ \mu F < C_R \leq 0.22\ \mu F$
at 20 °C	1 kHz	–	1.0
(upper limit values)	10 kHz	–	1.5
	100 kHz	4.0	–
Insulation resistance R_{ins} at 20 °C, rel. humidity ≤ 65% (minimum as-delivered values)	100 GΩ		
DC test voltage	$1.6 \cdot V_R$, 2 s		
Category voltage V_C	T_A (°C)	DC voltage derating	AC voltage derating
(continuous operation with V_{DC}	$T_A \leq 85$	$V_C = V_R$	$V_{C,RMS} = V_{RMS}$
or V_{AC} at f ≤ 1 kHz)	$85 < T_A \leq 100$	$V_C = V_R \cdot (165 - T_A)/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$
Operating voltage V_{op}	T_A (°C)	DC voltage (max. hours)	AC voltage (max. hours)
for short operating periods	$T_A \leq 85$	$V_{op} = 1.25 \cdot V_C$ (2000 h)	$V_{op} = 1.0 \cdot V_{C,RMS}$ (2000 h)
(V_{DC} or V_{AC} at f ≤ 1 kHz)	$85 < T_A \leq 100$	$V_{op} = 1.25 \cdot V_C$ (1000 h)	$V_{op} = 1.0 \cdot V_{C,RMS}$ (1000 h)
Damp heat test	56 days/40 °C/93% relative humidity		
Limit values after damp	Capacitance change |ΔC/C|		≤ 3%
heat test	Dissipation factor change Δ tan δ		$\leq 0.5 \cdot 10^{-3}$ (at 1 kHz)
			$\leq 1.0 \cdot 10^{-3}$ (at 10 kHz)
	Insulation resistance R_{ins}		≥ 50% of minimum as-delivered values
Reliability:			
Failure rate λ	1 fit ($\leq 1 \cdot 10^{-9}$/h) at $0.5 \cdot V_R$, 40 °C		
Service life t_{SL}	200 000 h at $1.0 \cdot V_R$, 85 °C		
	For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability".		
Failure criteria:			
Total failure	Short circuit or open circuit		
Failure due to variation	Capacitance change |ΔC/C|		> ±10%
of parameters	Dissipation factor tan δ		> 4 · upper limit value
	Insulation resistance R_{ins}		< 1500 MΩ

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/µs.

"k_0" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V^2/µs.

Note:
The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

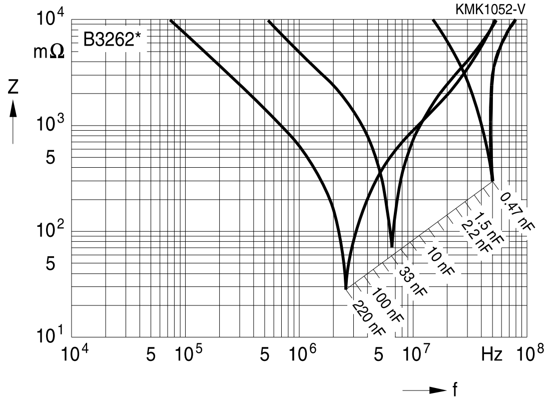
dV/dt values

Lead spacing		7.5 mm	10 mm
V_R V DC	V_{RMS} V AC	dV/dt in V/µs	
160	90	750	600
250	140	1 200	900
400	200	1 500	1 050
630	400	2 700	1 800
1 000	500	3 200	2 400
1 000	600	4 000	–

k_0 values

Lead spacing		7.5 mm	10 mm
V_R V DC	V_{RMS} V AC	k_0 in V^2/µs	
160	90	240 000	190 000
250	140	600 000	450 000
400	200	1 200 000	840 000
630	400	3 400 000	2 250 000
1 000	500	6 400 000	4 800 000
1 000	600	8 000 000	–

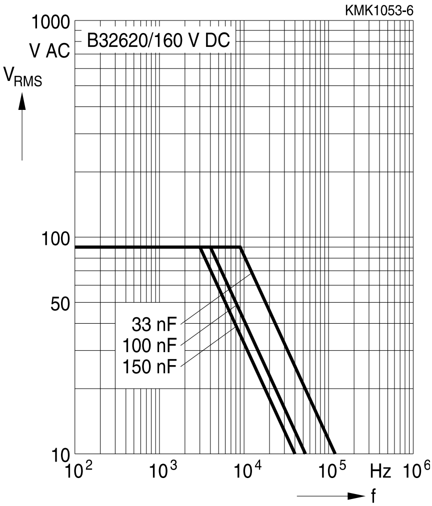
Impedance Z versus frequency f
(typical values)



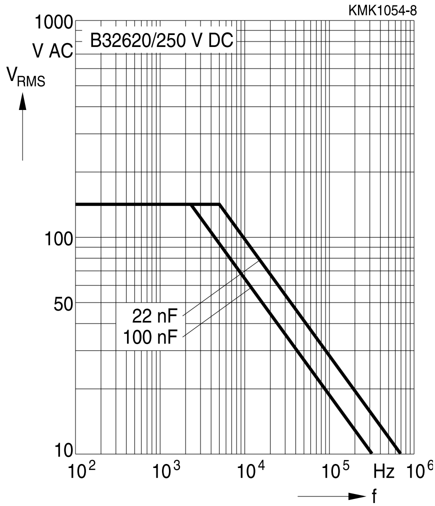
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90$ °C)
For $T_A > 90$ °C, please refer to "General technical information", section 3.2.3.

Lead spacing 7.5 mm

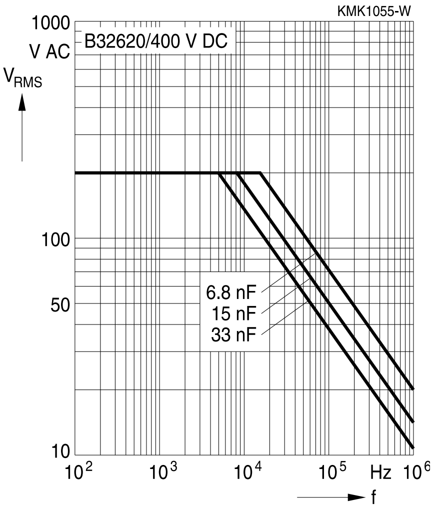
160 V DC/90 V AC



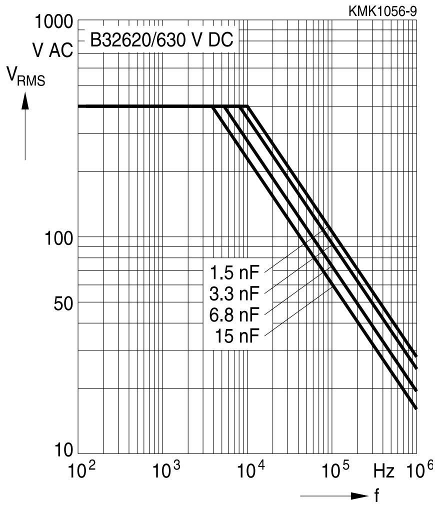
250 V DC/140 V AC



400 V DC/200 V AC



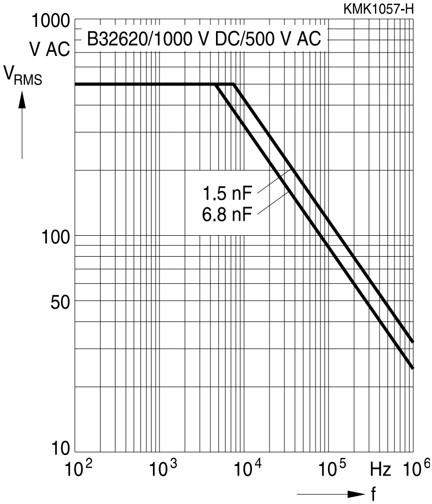
630 V DC/400 V AC



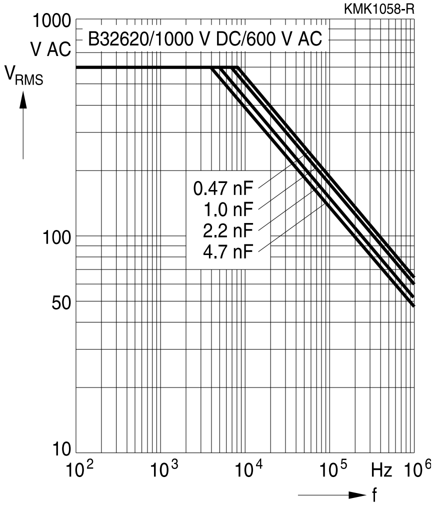
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90$ °C)
For $T_A > 90$ °C, please refer to "General technical information", section 3.2.3.

Lead spacing 7.5 mm

1000 V DC/500 V AC



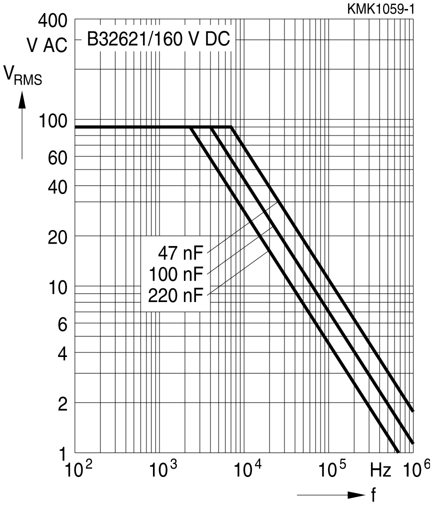
1000 V DC/600 V AC



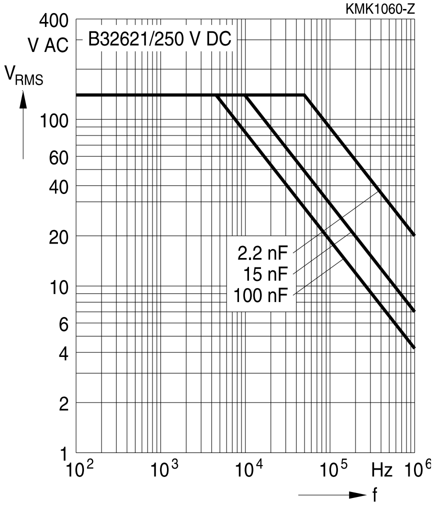
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90$ °C)
For T_A >90 °C, please refer to "General technical information", section 3.2.3.

Lead spacing 10 mm

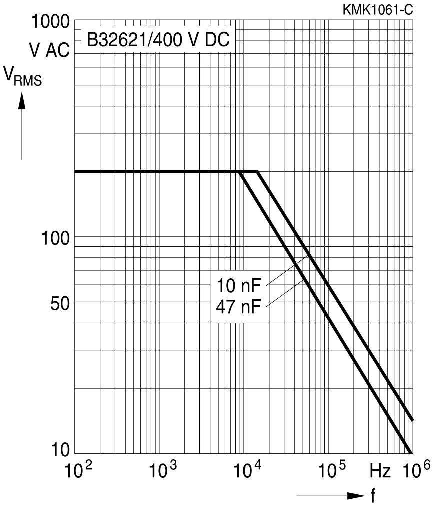
160 V DC/90 V AC



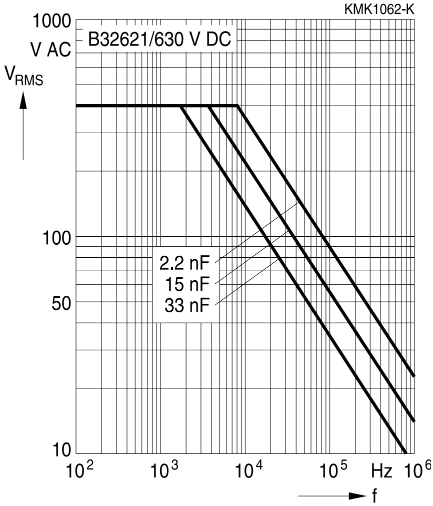
250 V DC/140 V AC



400 V DC/200 V AC



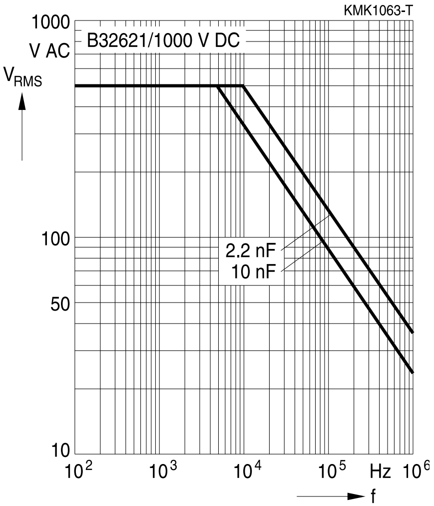
630 V DC/400 V AC



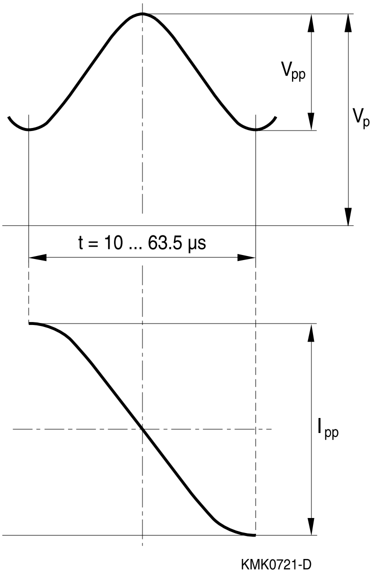
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90$ °C)
For $T_A > 90$ °C, please refer to "General technical information", section 3.2.3.

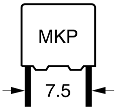
Lead spacing 10 mm

1000 V DC/500 V AC



Sinus-wave application, lighting
Permissible voltage and current / waveform

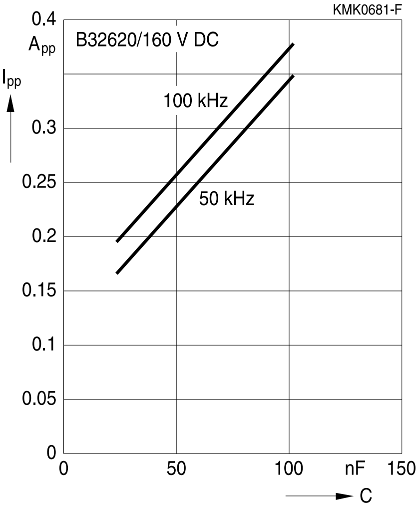




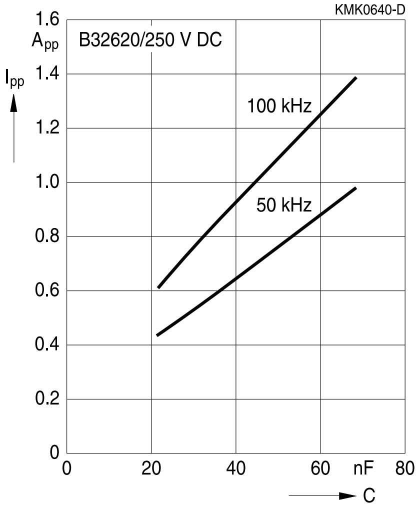
Sinus-wave application, lighting
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 7.5 mm

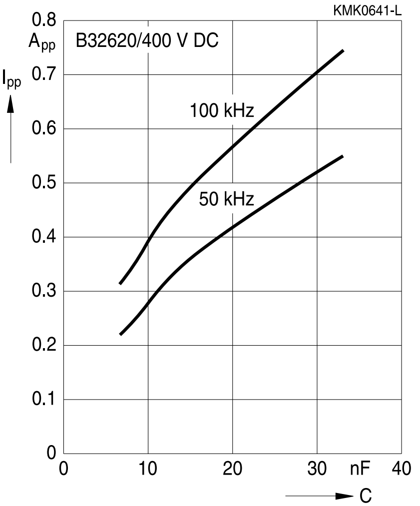
160 V DC/90 V AC



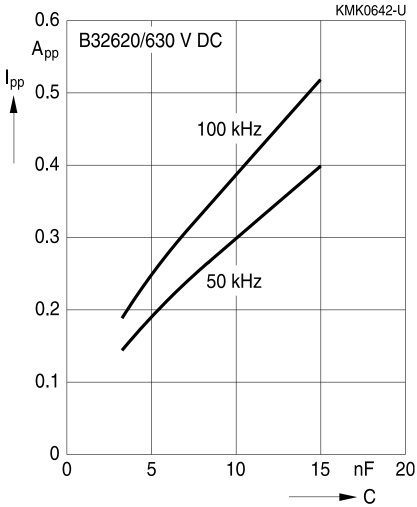
250 V DC/140 V AC



400 V DC/200 V AC



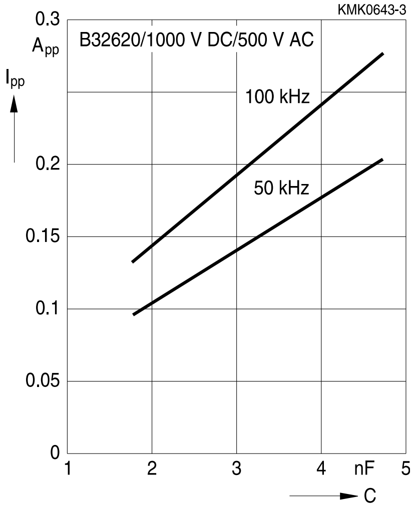
630 V DC/400 V AC



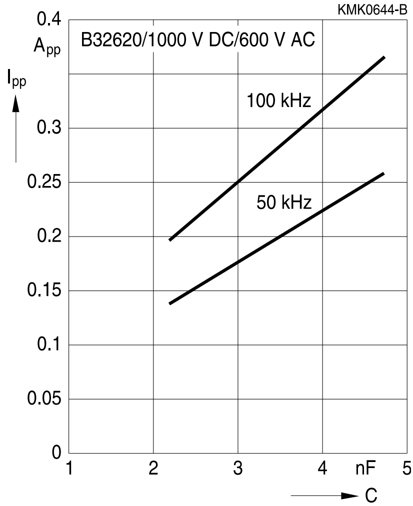
Sinus-wave application, lighting
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 7.5 mm

1000 V DC/500 V AC



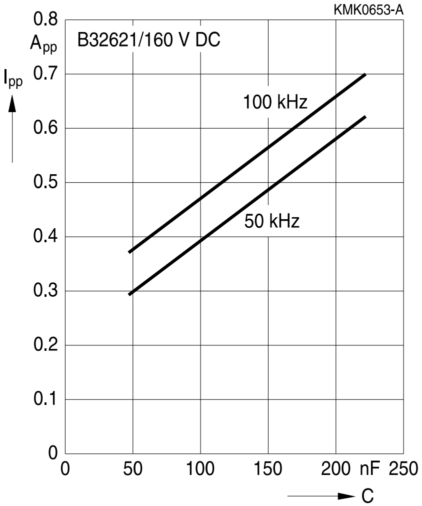
1000 V DC/600 V AC



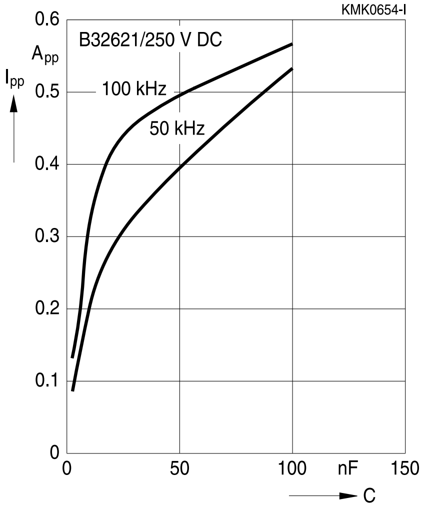
Sinus-wave application, lighting
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 10 mm

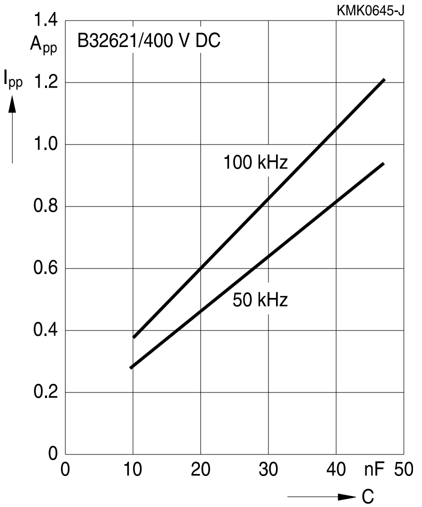
160 V DC/90 V AC



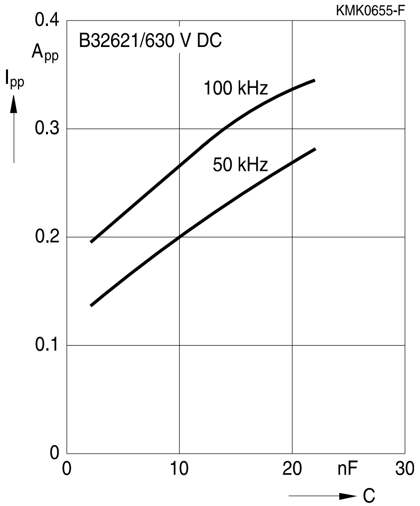
250 V DC/140 V AC



400 V DC/200 V AC



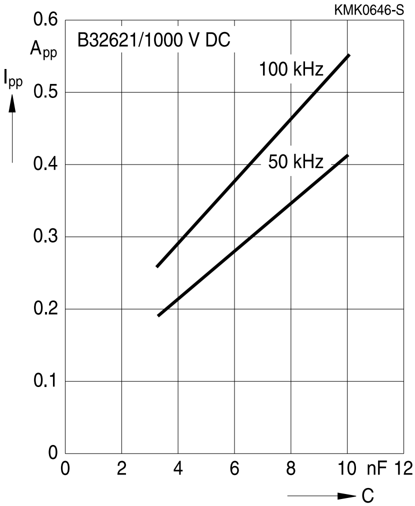
630 V DC/400 V AC



Sinus-wave application, lighting
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 10 mm

1000 V DC/500 V AC



Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

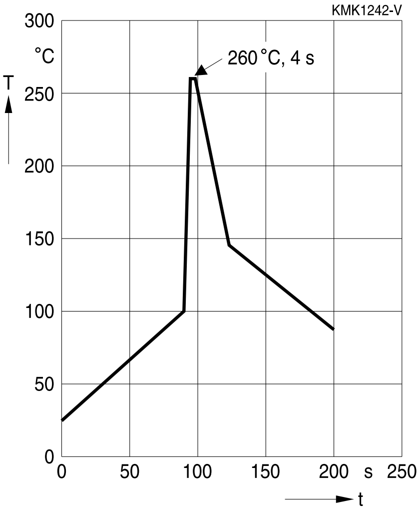
Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Evaluation criteria: Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.
Conditions:

Series		Solder bath temperature	Soldering time
MKT	boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	 (lead spacing > 7.5 mm)		
MKT	boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP MKT	(lead spacing ≤ 7.5 mm) uncoated (lead spacing ≤ 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
tan δ	As specified in sectional specification

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max}. Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
  diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

<table>
<tr><th>Type</th><th>Ethanol,
isopropanol,
n-propanol</th><th>n-propanol-water mixtures,
water with surface tension-reducing tensides (neutral)</th><th>Solvent from table A (see next page)</th><th>Solvent from table B (see next page)</th></tr>
<tr><td>MKT
(uncoated)</td><td rowspan="2">Suitable</td><td>Unsuitable</td><td>In part suitable</td><td rowspan="2">Unsuitable</td></tr>
<tr><td>MKT, MKP, MFP
(coated/boxed)</td><td>Suitable</td><td>Suitable</td></tr>
</table>

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 °C) before they are subjected to subsequent electrical testing.

Table A

Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro-ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil

3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 °C.

Caution:
Consult us first if you wish to embed uncoated types!

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"

Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_C	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β_C	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f_1	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I_C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)

Symbol	English	German
I_{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
L_S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
T	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$\tan\delta$	Dissipation factor	Verlustfaktor
$\tan\delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan\delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
$\tan\delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Ambient temperature	Umgebungstemperatur
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T_{op}	Operating temperature	Beriebstemperatur
T_R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer
V_{AC}	AC voltage	Wechselspannung

Symbol	English	German
V_C	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_i	Input voltage	Eingangsspannung
V_o	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
$\hat{v}_R$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
$\boxed{e}$	Lead spacing	Rastermaß

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The following applies to all products named in this publication:

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